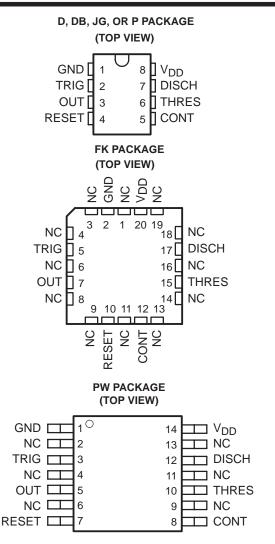
- Very Low Power Consumption
 1 mW Typ at V_{DD} = 5 V
- Capable of Operation in Astable Mode
- CMOS Output Capable of Swinging Rail to Rail
- High Output-Current Capability
 - Sink 100 mA Typ
 - Source 10 mA Typ
- Output Fully Compatible With CMOS, TTL, and MOS
- Low Supply Current Reduces Spikes During Output Transitions
- Single-Supply Operation From 2 V to 15 V
- Functionally Interchangeable With the NE555; Has Same Pinout
- ESD Protection Exceeds 2000 V Per MIL-STD-883C, Method 3015.2
- Available in Q-Temp Automotive
 High Reliability Automotive Applications
 Configuration Control/Print Support
 Qualification to Automotive Standards

description

The TLC555 is a monolithic timing circuit fabricated using the TI LinCMOS™ process. The timer is fully compatible with CMOS, TTL, and MOS logic and operates at frequencies up to 2 MHz. Because of its high input impedance, this device uses smaller timing capacitors than those used by the NE555. As a result, more accurate time delays and oscillations are possible. Power consumption is low across the full range of power supply voltage.



NC - No internal connection

Like the NE555, the TLC555 has a trigger level equal to approximately one-third of the supply voltage and a threshold level equal to approximately two-thirds of the supply voltage. These levels can be altered by use of the control voltage terminal (CONT). When the trigger input (TRIG) falls below the trigger level, the flip-flop is set and the output goes high. If TRIG is above the trigger level and the threshold input (THRES) is above the threshold level, the flip-flop is reset and the output is low. The reset input (RESET) can override all other inputs and can be used to initiate a new timing cycle. If RESET is low, the flip-flop is reset and the output is low. Whenever the output is low, a low-impedance path is provided between the discharge terminal (DISCH) and GND. All unused inputs should be tied to an appropriate logic level to prevent false triggering.

While the CMOS output is capable of sinking over 100 mA and sourcing over 10 mA, the TLC555 exhibits greatly reduced supply-current spikes during output transitions. This minimizes the need for the large decoupling capacitors required by the NE555.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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description (continued)

The TLC555C is characterized for operation from 0° C to 70° C. The TLC555I is characterized for operation from -40° C to 85° C. The TLC555Q is characterized for operation over the automotive temperature range of -40° C to 125° C. The TLC555M is characterized for operation over the full military temperature range of -55° C to 125° C.

AVAILABLE OPTIONS[†]

	PACKAGED DEVICES											
TA	V _{DD} RANGE	SMALL OUTLINE (D) [‡]	SSOP (DB) [‡]	CHIP CARRIER (FK)	CERAMIC DIP (JG)							
0°C to 70°C	2 V to 15 V	TLC555CD	TLC555CDB	_	_	TLC555CP	TLC555CPW					
-40°C to 85°C	3 V to 15 V	TLC555ID	_	_	_	TLC555IP	_					
-40°C to 125°C	5 V to 15 V	TLC555QD	_	_	_	_	_					
-55°C to 125°C	5 V to 15 V	TLC555MD	_	TLC555MFK	TLC555MJG	TLC555MP	_					

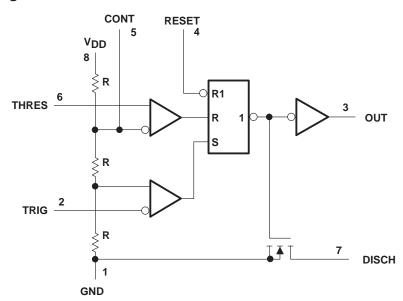
T For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.

FUNCTION TABLE

RESET VOLTAGE‡	TRIGGER VOLTAGE‡	THRESHOLD VOLTAGE‡	OUTPUT	DISCHARGE SWITCH
<min< td=""><td>Irrelevant</td><td>Irrelevant</td><td>L</td><td>On</td></min<>	Irrelevant	Irrelevant	L	On
>MAX	<min< td=""><td>Irrelevant</td><td>Н</td><td>Off</td></min<>	Irrelevant	Н	Off
>MAX	>MAX	>MAX	L	On
>MAX	>MAX	<min< td=""><td>As prev</td><td>iously established</td></min<>	As prev	iously established

[‡]For conditions shown as MIN or MAX, use the appropriate value specified under electrical characteristics.

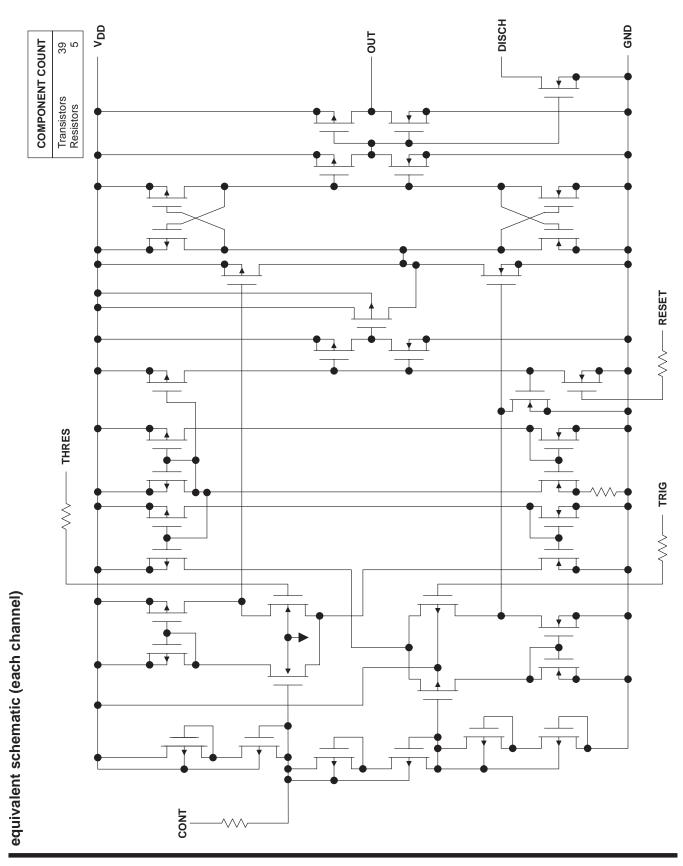
functional block diagram



Pin numbers are for all packages except the FK package. RESET can override TRIG, which can override THRES.



[‡] This package is available taped and reeled. Add the R suffix to device type (e.g., TLC555CDR).





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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

		15 mA
Continuous total power dissipation		See Dissipation Rating Table
Operating free-air temperature range, T _A :	C-suffix	0°C to 70°C
	I-suffix	–40°C to 85°C
	Q-suffix	–40°C to 125°C
	M-suffix	–55°C to 125°C
Storage temperature range		–65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from	case for 60 s	econds: JG package
Lead temperature 1,6 mm (1/16 inch) from	case for 10 s	econds: D, DB, P, or PW package 260°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: All voltage values are with respect to network GND.

DISSIPATION RATING TABLE

PACKAGE	$T_{\mbox{A}} \le 25^{\circ}\mbox{C}$ POWER RATING	DERATING FACTOR ABOVE T _A = 25°C	T _A = 70°C POWER RATING	T _A = 85°C POWER RATING	T _A = 125°C POWER RATING
D	725 mW	5.8 mW/°C	464 mW	377 mW	145 mW
DB	525 mW	4.2 mW/°C	336 mW	273 mW	105 mW
FK	1375 mW	11.0 mW/°C	880 mW	715 mW	275 mW
JG	1050 mW	8.4 mW/°C	672 mW	546 mW	210 mW
Р	1000 mW	8.0 mW/°C	640 mW	520 mW	200 mW
PW	525 mW	4.2 mW/°C	336 mW	273 mW	105 mW

recommended operating conditions

		MIN	MAX	UNIT
Supply voltage, V _{DD}		2	15	V
	TLC555C	0	70	
Operating free air temperature range T.	TLC555I	-40	85	°C
Operating free-air temperature range, T _A	TLC555Q	-40	125	-0
	TLC555M	-55	125	



electrical characteristics at specified free-air temperature, V_{DD} = 2 V for TLC555C, V_{DD} = 3 V for TLC555I

		TEST	_ +	T	LC555C		7	TLC555I		
	PARAMETER	CONDITIONS	T _A †	MIN	TYP	MAX	MIN	TYP	MAX	UNIT
\/	Three hald walks as		25°C	0.95	1.33	1.65	1.6		2.4	V
V _{IT}	Threshold voltage		Full range	0.85		1.75	1.5		2.5	V
	The section of the section of		25°C		10			10		A
ΙΙΤ	Threshold current		MAX		75			150		pА
.,			25°C	0.4	0.67	0.95	0.71	1	1.29	.,
V _I (TRIG)	Trigger voltage		Full range	0.3		1.05	0.61		1.39	V
	Triangular		25°C		10			10		A
l _(TRIG)	Trigger current		MAX		75			150		pA
.,	5		25°C	0.4	1.1	1.5	0.4	1.1	1.5	.,
V _I (RESET)	Reset voltage		Full range	0.3		2	0.3		1.8	V
			25°C		10			10		
I(RESET)	Reset current		MAX		75			150		pA
	Control voltage (open circuit) as a percentage of supply voltage		MAX		66.7%			66.7%		
	Discharge switch on-stage		25°C		0.03	0.2		0.03	0.2	.,
	voltage	I _{OL} = 1 mA	Full range			0.25			0.375	V
	Discharge switch off-stage		25°C		0.1			0.1		
	current		MAX		0.5			120		nA
.,			25°C	1.5	1.9		2.5	2.85		.,
VOH	High-level output voltage	$I_{OH} = -300 \mu A$	Full range	1.5			2.5			V
.,			25°C		0.07	0.3		0.07	0.3	.,
VOL	Low-level output voltage	I _{OL} = 1 mA	Full range			0.35			0.4	V
l	Cupply ourrant	See Note 2	25°C			250			250	
IDD	Supply current	See Note 2	Full range			400			500	μΑ

[†] Full range is 0°C to 70°C for the TLC555C and –40°C to 85°C for the TLC555I. For conditions shown as MAX, use the appropriate value specified in the recommended operating conditions table.

NOTE 2: These values apply for the expected operating configurations in which THRES is connected directly to DISCH or to TRIG.



electrical characteristics at specified free-air temperature, $V_{DD} = 5 V$

		TEST	- +	٦	TLC555C			TLC555I		TLC55	5Q, TLC	555M	UNIT
	PARAMETER	CONDITIONS	T _A †	MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	UNII
\/	Thereboldesikess		25°C	2.8	3.3	3.8	2.8	3.3	3.8	2.8	3.3	3.8	V
V _{IT}	Threshold voltage		Full range	2.7		3.9	2.7		3.9	2.7		3.9	V
1	There had a consent		25°C		10			10			10		- 4
'IT	Threshold current		MAX		75			150			5000		pА
V	Tringer veltege		25°C	1.36	1.66	1.96	1.36	1.66	1.96	1.36	1.66	1.96	V
V _I (TRIG)	Trigger voltage		Full range	1.26		2.06	1.26		2.06	1.26		2.06	V
1	Tringer europt		25°C		10			10			10		- ^
l(TRIG)	Trigger current		MAX		75			150			5000		pА
V	Denot voltoge		25°C	0.4	1.1	1.5	0.4	1.1	1.5	0.4	1.1	1.5	V
V _I (RESET)	Reset voltage		Full range	0.3		1.8	0.3		1.8	0.3		1.8	V
1	Dt		25°C		10			10			10		- 4
I(RESET)	Reset current		MAX		75			150			5000		pА
	Control voltage (open circuit) as a percentage of supply voltage		MAX		66.7%			66.7%			66.7%		
	Discharge switch	101	25°C		0.14	0.5		0.14	0.5		0.14	0.5	V
	on-state voltage	$I_{OL} = 10 \text{ mA}$	Full range			0.6			0.6			0.6	V
	Discharge switch		25°C		0.1			0.1			0.1		A
	off-state current		MAX		0.5			120			120		nA
.,	High-level output		25°C	4.1	4.8		4.1	4.8		4.1	4.8		.,
Vон	voltage	$I_{OH} = -1 \text{ mA}$	Full range	4.1			4.1			4.1			V
		1- 0 m 1	25°C		0.21	0.4		0.21	0.4		0.21	0.4	
		I _{OL} = 8 mA	Full range			0.5			0.5			0.6	
V	Low-level output		25°C		0.13	0.3		0.13	0.3		0.13	0.3	V
VOL	voltage	$I_{OL} = 5 \text{ mA}$	Full range			0.4			0.4			0.45	V
		le 2.2 mA	25°C		0.08	0.3		0.08	0.3		0.08	0.3	
		$I_{OL} = 3.2 \text{ mA}$	Full range			0.35			0.35			0.4	
	Cupply ourrent	See Note 2	25°C		170	350		170	350		170	350	
IDD	Supply current	See Note 2	Full range			500			600			700	μΑ

[†] Full range is 0°C to 70°C the for TLC555C, -40°C to 85°C for the TLC555I, -40°C to 125°C for the TLC555Q, and -55°C to 125°C for the TLC555M. For conditions shown as MAX, use the appropriate value specified in the recommended operating conditions table.

NOTE 2: These values apply for the expected operating configurations in which THRES is connected directly to DISCH or TRIG.



electrical characteristics at specified free-air temperature, $V_{\mbox{\scriptsize DD}}$ = 15 V

	ADAMETED	TEST	- +	-	TLC555C			TLC555I		TLC55	5Q, TLC	555M	
Р	ARAMETER	CONDITIONS	T _A †	MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	UNIT
V	Threehold veltage		25°C	9.45	10	10.55	9.45	10	10.55	9.45	10	10.55	V
V _{IT}	Threshold voltage		Full range	9.35		10.65	9.35		10.65	9.35		10.65	V
1	Threshold current		25°C		10			10			10		- ^
^I IT	Threshold current		MAX		75			150			5000		pA
V	Triages veltage		25°C	4.65	5	5.35	4.65	5	5.35	4.65	5	5.35	V
V _I (TRIG)	Trigger voltage		Full range	4.55		5.45	4.55		5.45	4.55		5.45	V
1	Trigger current		25°C		10			10			10		- ^
l(TRIG)	rngger current		MAX		75			150			5000		pA
V	Danat walkana		25°C	0.4	1.1	1.5	0.4	1.1	1.5	0.4	1.1	1.5	V
VI(RESET)	Reset voltage		Full range	0.3		1.8	0.3		1.8	0.3		1.8	V
1	Decet current		25°C		10			10			10		- ^
I(RESET)	Reset current		MAX		75			150			5000		pA
	Control voltage (open circuit) as a percentage of supply voltage		MAX		66.7%			66.7%			66.7%		
	Discharge switch		25°C		0.77	1.7		0.77	1.7		0.77	1.7	.,
	on-state voltage	I _{OL} = 100 mA	Full range			1.8			1.8			1.8	V
	Discharge switch		25°C		0.1			0.1			0.1		
	off-state current		MAX		0.5			120			120		nA
			25°C	12.5	14.2		12.5	14.2		12.5	14.2		
		$I_{OH} = -10 \text{ mA}$	Full range	12.5			12.5			12.5			
.,	High-level output		25°C	13.5	14.6		13.5	14.6		13.5	14.6		V
VOH	voltage	$I_{OH} = -5 \text{ mA}$	Full range	13.5			13.5			13.5			V
		4 4	25°C	14.2	14.9		14.2	14.9		14.2	14.9		
		$I_{OH} = -1 \text{ mA}$	Full range	14.2			14.2			14.2			
		100 1	25°C		1.28	3.2		1.28	3.2		1.28	3.2	
		I _{OL} = 100 mA	Full range			3.6			3.7			3.8	
	Low-level output	I	25°C		0.63	1		0.63	1		0.63	1	V
VOL	voltage	I _{OL} = 50 mA	Full range			1.3			1.4			1.5	V
		Ja: - 10 m/	25°C		0.12	0.3		0.12	0.3		0.12	0.3	
		I _{OL} = 10 mA	Full range			0.4			0.4			0.45	
<u> </u>	Cumply ourrant	Coo Note 2	25°C		360	600		360	600		360	600	
IDD	Supply current	See Note 2	Full range			800			900			1000	μΑ

[†] Full range is 0°C to 70°C for TLC555C, -40°C to 85°C for TLC555I, -40°C to 125°C for the TLC555Q, and -55°C to 125°C for TLC555M. For conditions shown as MAX, use the appropriate value specified in the recommended operating conditions table.

NOTE 2: These values apply for the expected operating configurations in which THRES is connected directly to DISCH or TRIG.

operating characteristics, V_{DD} = 5 V, T_A = 25°C (unless otherwise noted)

	PARAMETER	TEST	CONDITIONS	MIN	TYP	MAX	UNIT
	Initial error of timing interval‡	$V_{DD} = 5 \text{ V to } 15 \text{ V},$	$R_A = R_B = 1 \text{ k}\Omega \text{ to } 100 \text{ k}\Omega,$		1%	3%	
	Supply voltage sensitivity of timing interval	$C_T = 0.1 \mu F$,	See Note 3		0.1	0.5	%/V
t _r	Output pulse rise time	D 40.MO	0 40 = F		20	75	
tf	Output pulse fall time	$R_L = 10 M\Omega$,	C _L = 10 pF		15	60	ns
f _{max}	Maximum frequency in astable mode	$R_A = 470 \Omega,$ $C_T = 200 pF,$	$R_B = 200 \Omega$, See Note 3	1.2	2.1		MHz

[‡] Timing interval error is defined as the difference between the measured value and the average value of a random sample from each process run.

electrical characteristics at V_{DD} = 5 V, T_A = 25°C

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
V _{IT}	Threshold voltage		2.8	3.3	3.8	V
I _I T	Threshold current			10		pА
V _I (TRIG)	Trigger voltage		1.36	1.66	1.96	V
I _I (TRIG)	Trigger current			10		pА
V _I (RESET)	Reset voltage		0.4	1.1	1.5	V
I(RESET)	Reset current			10		рА
	Control voltage (open circuit) as a percentage of supply voltage			66.7%		
	Discharge switch on-state voltage	I _{OL} = 10 mA		0.14	0.5	V
	Discharge switch off-state current			0.1		nA
Vон	High-level output voltage	I _{OH} = - 1 mA	4.1	4.8		V
		$I_{OL} = 8 \text{ mA}$		0.21	0.4	
VOL	Low-level output voltage	$I_{OL} = 5 \text{ mA}$		0.13	0.3	V
		$I_{OL} = 3.2 \text{ mA}$		0.08	0.3	
I _{DD}	Supply current	See Note 2		170	350	μΑ

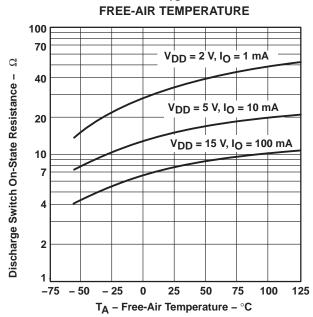
NOTE 2: These values apply for the expected operating configurations in which THRES is connected directly to DISCH or TRIG.



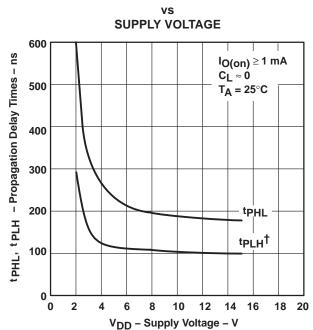
NOTE 3: R_A , R_B , and C_T are as defined in Figure 1.

TYPICAL CHARACTERISTICS

DISCHARGE SWITCH ON-STATE RESISTANCE vs



PROPAGATION DELAY TIMES TO DISCHARGE OUTPUT FROM TRIGGER AND THRESHOLD SHORTED TOGETHER

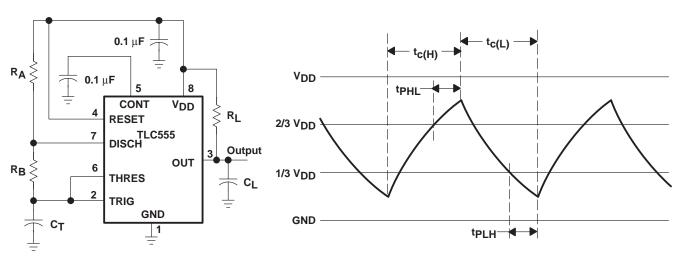


† The effects of the load resistance on these values must be taken into account separately.

Figure 1

Figure 2

APPLICATION INFORMATION



Pin numbers shown are for all packages except the FK package.

CIRCUIT

TRIGGER AND THRESHOLD VOLTAGE WAVEFORM

Figure 3. Astable Operation



APPLICATION INFORMATION

Connecting TRIG to THRES, as shown in Figure 3, causes the timer to run as a multivibrator. The capacitor C_T charges through R_A and R_B to the threshold voltage level (approximately 0.67 V_{DD}) and then discharges through R_B only to the value of the trigger voltage level (approximately 0.33 V_{DD}). The output is high during the charging cycle ($t_{C(H)}$) and low during the discharge cycle ($t_{C(L)}$). The duty cycle is controlled by the values of R_A , R_B , and C_T as shown in the equations below.

$$\begin{array}{l} t_{c(H)} \ \approx \ C_T \, (R_A \ + \ R_B) \ \text{ln 2} \quad (\text{ln 2} = 0.693) \\ t_{c(L)} \ \approx \ C_T \, R_B \ \text{ln 2} \\ \text{Period} \ = \ t_{c(H)} \ + \ t_{c(L)} \ \approx \ C_T \, (R_A \ + \ 2R_B) \ \text{ln 2} \\ \text{Output driver duty cycle} \ = \ \frac{t_{c(L)}}{t_{c(H)} \ + \ t_{c(L)}} \ \approx \ 1 - \frac{R_B}{R_A \ + \ 2R_B} \\ \text{Output waveform duty cycle} \ = \ \frac{t_{c(H)}}{t_{c(H)} \ + \ t_{c(L)}} \ \approx \ \frac{R_B}{R_A \ + \ 2R_B} \end{array}$$

The 0.1-μF capacitor at CONT in Figure 3 decreases the period by about 10%.

The formulas shown above do not allow for any propagation delay times from the TRIG and THRES inputs to DISCH. These delay times add directly to the period and create differences between calculated and actual values that increase with frequency. In addition, the internal on-state resistance r_{on} during discharge adds to R_{B} to provide another source of timing error in the calculation when R_{B} is very low or r_{on} is very high.

The equations below provide better agreement with measured values.

$$t_{c(H)} = C_{T}(R_{A} + R_{B}) \ln \left[3 - \exp\left(\frac{-t_{PLH}}{C_{T}(R_{B} + r_{on})}\right) \right] + t_{PHL}$$

$$t_{c(L)} = C_{T}(R_{B} + r_{on}) \ln \left[3 - \exp\left(\frac{-t_{PHL}}{C_{T}(R_{A} + R_{B})}\right) \right] + t_{PLH}$$

These equations and those given earlier are similar in that a time constant is multiplied by the logarithm of a number or function. The limit values of the logarithmic terms must be between In 2 at low frequencies and In 3 at extremely high frequencies. For a duty cycle close to 50%, an appropriate constant for the logarithmic terms can be substituted

with good results. Duty cycles less than 50%
$$\frac{^tc(H)}{^tc(H)}$$
 require that $\frac{^tc(H)}{^tc(L)}$ <1 and possibly $R_A \le r_{on}$. These

conditions can be difficult to obtain.

In monostable applications, the trip point on TRIG can be set by a voltage applied to CONT. An input voltage between 10% and 80% of the supply voltage from a resistor divider with at least 500-μA bias provides good results.





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PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/ Ball Finish	MSL Peak Temp ⁽³⁾	Samples (Requires Login)
5962-89503012A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	Purchase Samples
5962-8950301PA	ACTIVE	CDIP	JG	8	1	TBD	A42	N / A for Pkg Type	Purchase Samples
TLC555CD	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
TLC555CDG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
TLC555CDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Request Free Samples
TLC555CDRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Request Free Sample
TLC555CP	ACTIVE	PDIP	Р	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	Request Free Sample
TLC555CPE4	ACTIVE	PDIP	Р	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	Request Free Sample
TLC555CPSR	ACTIVE	SO	PS	8	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Request Free Sample
TLC555CPSRG4	ACTIVE	SO	PS	8	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Request Free Sample
TLC555CPW	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Contact TI Distributor or Sales Office
TLC555CPWG4	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Contact TI Distributo or Sales Office
TLC555CPWR	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Request Free Sample
TLC555CPWRG4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Request Free Sample
TLC555ID	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
TLC555IDG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
TLC555IDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
TLC555IDRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
TLC555IP	ACTIVE	PDIP	Р	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	Request Free Sample





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Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/ Ball Finish	MSL Peak Temp ⁽³⁾	Samples (Requires Login)
TLC555IPE4	ACTIVE	PDIP	Р	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	Request Free Samples
TLC555MFKB	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	Purchase Samples
TLC555MJG	ACTIVE	CDIP	JG	8	1	TBD	A42	N / A for Pkg Type	Purchase Samples
TLC555MJGB	ACTIVE	CDIP	JG	8	1	TBD	A42	N / A for Pkg Type	Purchase Samples
TLC555MP	OBSOLETE	PDIP	Р	8		TBD	Call TI	Call TI	Samples Not Available
TLC555QDR	ACTIVE	SOIC	D	8	2500	TBD	CU NIPDAU	Level-1-220C-UNLIM	Request Free Samples
TLC555QDRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. **Pb-Free** (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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OTHER QUALIFIED VERSIONS OF TLC555, TLC555M:





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• Automotive: TLC555-Q1, TLC555-Q1

Military: TLC555M

NOTE: Qualified Version Definitions:

Catalog - TI's standard catalog product

• Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

• Military - QML certified for Military and Defense Applications

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

All differsions are norminal												
Device		Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TLC555CDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
TLC555CPSR	SO	PS	8	2000	330.0	16.4	8.2	6.6	2.5	12.0	16.0	Q1
TLC555CPWR	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
TLC555IDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1

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*All dimensions are nominal

7 il difficiolo de ficilifica								
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)	
TLC555CDR	SOIC	D	8	2500	340.5	338.1	20.6	
TLC555CPSR	SO	PS	8	2000	346.0	346.0	33.0	
TLC555CPWR	TSSOP	PW	14	2000	346.0	346.0	29.0	
TLC555IDR	SOIC	D	8	2500	340.5	338.1	20.6	

JG (R-GDIP-T8)

CERAMIC DUAL-IN-LINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification.
- E. Falls within MIL STD 1835 GDIP1-T8

FK (S-CQCC-N**)

28 TERMINAL SHOWN

LEADLESS CERAMIC CHIP CARRIER



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. The terminals are gold plated.
- E. Falls within JEDEC MS-004



P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE PACKAGE

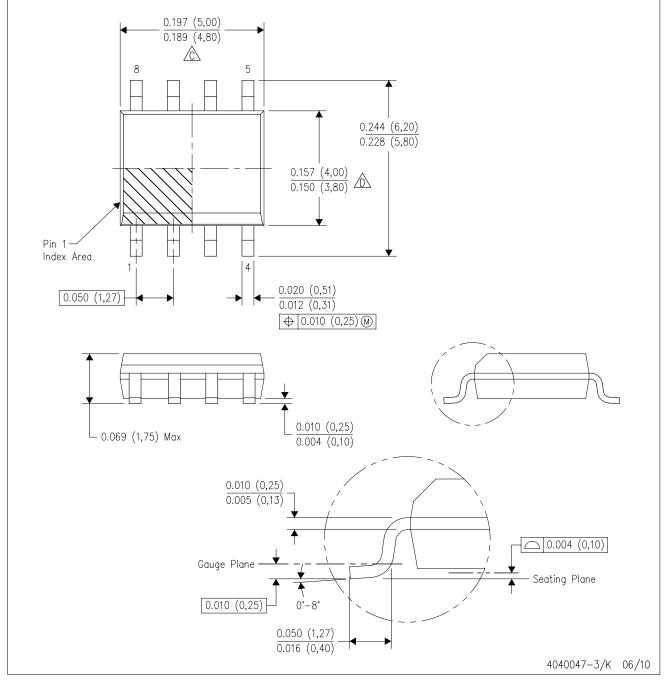


- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-001 variation BA.



D (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE

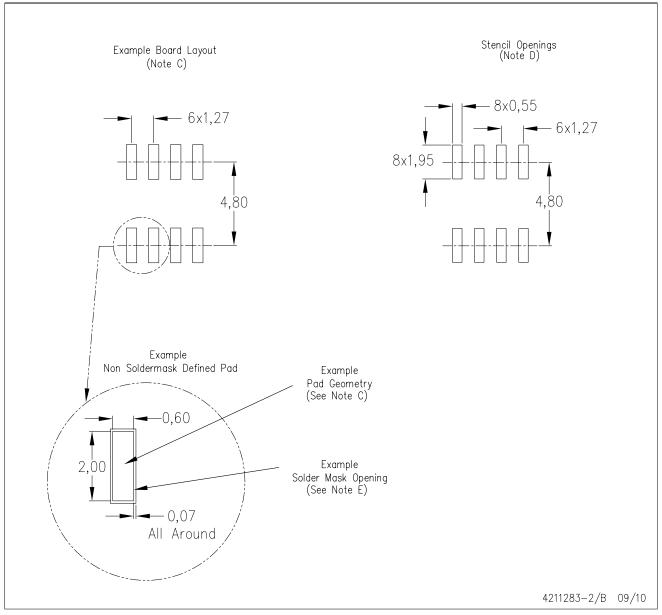


- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.
- Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.
- E. Reference JEDEC MS-012 variation AA.



D (R-PDSO-G8)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.





NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



PW (R-PDSO-G**)

14 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

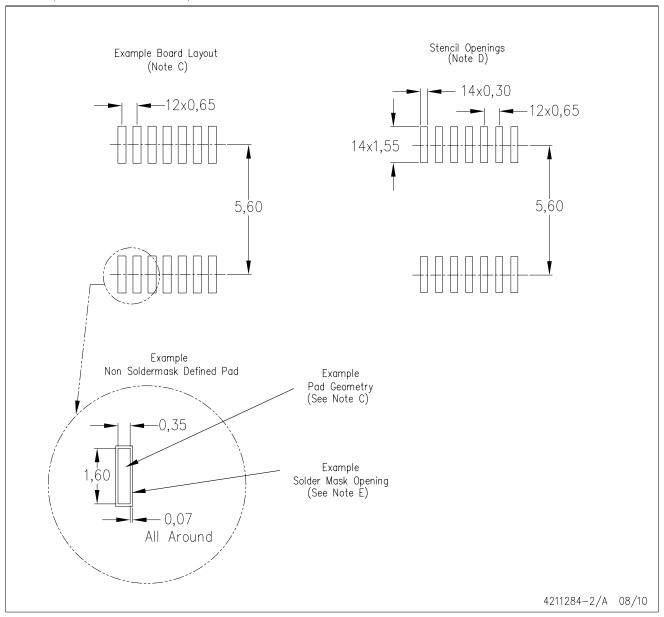
B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

PW (R-PDSO-G14)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



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